

Dynasolve™ M-35



Uncured Epoxy Flushing Solvent



Dynasolve M-35 is a formulated solvent which is used for flushing uncured epoxy in a broad range of applications. It is also very effective at removing cured cyanoacrylate adhesives.

CLEANING APPLICATIONS:

Flushing epoxy metering and mixing equipment
Removal of cyanoacrylate adhesives from parts

ADVANTAGES:

More efficient than acetone, MEK & other solvents
Noncorrosive and has a low vapor pressure
High flash point
Can be used at room temperature
High loading capacity allows for reuse and reduced cost of ownership

SPECIFICATIONS:

Specific gravity:	1.20
Boiling point:	374°F (190°C)
Flash point:	221°F (105°C)

MATERIALS REMOVED:

Uncured epoxy
Cured cyanoacrylate adhesive

PRODUCT USAGE GUIDELINES

(SEE SDS FOR EH&S INFORMATION)

1. Dynasolve M-35 is typically used at room temperature. Heat to 140°– 170°F (60°– 76°C) for faster results.
2. Flush equipment of uncured epoxy.

MATERIAL COMPATIBILITY:

Recommended materials including:

All metals
Teflon®
Polyethylene & polypropylene

Avoid materials including:

Viton®
PVC
Neoprene



For more information, please contact us at:

VERSUM MATERIALS, LLC
VERSUMMATERIALS.COM

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